

# Linear Regulator - Low Dropout

1.5 A

## NCP565, NCV565

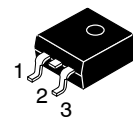
The NCP565/NCV565 low dropout linear regulator will provide 1.5 A at a fixed output voltage or an adjustable voltage down to 0.9 V. The fast loop response and low dropout voltage make this regulator ideal for applications where low voltage and good load transient response are important. Device protection includes current limit, short circuit protection, and thermal shutdown.

### Features

- Ultra Fast Transient Response ( $< 1.0 \mu\text{s}$ )
- Low Ground Current (1.5 mA at  $I_{\text{load}} = 1.5 \text{ A}$ )
- Low Dropout Voltage (0.9 V at  $I_{\text{load}} = 1.5 \text{ A}$ )
- Low Noise (28  $\mu\text{V}_{\text{rms}}$ )
- 0.9 V Reference Voltage
- Adjustable Output Voltage from 7.7 V down to 0.9 V
- 1.2 V, 1.5 V, 2.8 V, 3.0 V, 3.3 V Fixed Output Versions. Other Fixed Voltages Available on Request
- Current Limit Protection (3.3 A Typ)
- Thermal Shutdown Protection (160°C)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These are Pb-Free Devices

### Typical Applications

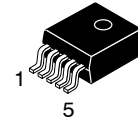
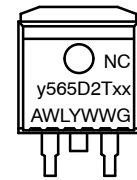
- Servers
- ASIC Power Supplies
- Post Regulation for Power Supplies
- Constant Current Source



**D2PAK 3  
CASE 936  
FIXED**

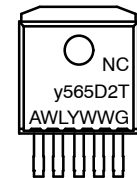
Tab = Ground  
Pin 1.  $V_{\text{in}}$   
2. Ground  
3.  $V_{\text{out}}$

### MARKING DIAGRAMS



**D2PAK 5  
CASE 936A  
ADJUSTABLE**

Tab = Ground  
Pin 1. N.C.  
2.  $V_{\text{in}}$   
3. Ground  
4.  $V_{\text{out}}$   
5. Adj



xx = 12 or 33  
y = P or V  
A = Assembly Location  
WL = Wafer Lot  
Y = Year  
WW = Work Week  
G = Pb-Free



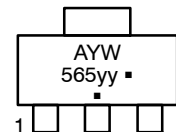
**DFN6, 3x3.3  
CASE 506AX**

xx = Voltage Rating  
AJ = Adjustable  
12 = 1.2 V 30 = 3.0V  
15 = 1.5 V 33 = 3.3 V  
28 = 2.8 V



**SOT-223  
CASE 318E**

yy = Voltage Rating  
12 = 1.2 V  
A = Assembly Location  
Y = Year  
W = Work Week  
▪ = Pb-Free Package



Tab =  $V_{\text{out}}$   
Pin 1. Ground  
2.  $V_{\text{out}}$   
3.  $V_{\text{in}}$

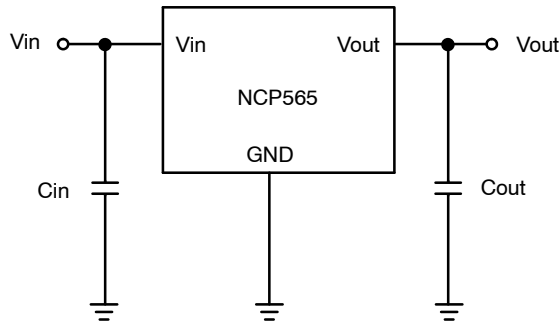
(Note: Microdot may be in either location)

### ORDERING INFORMATION

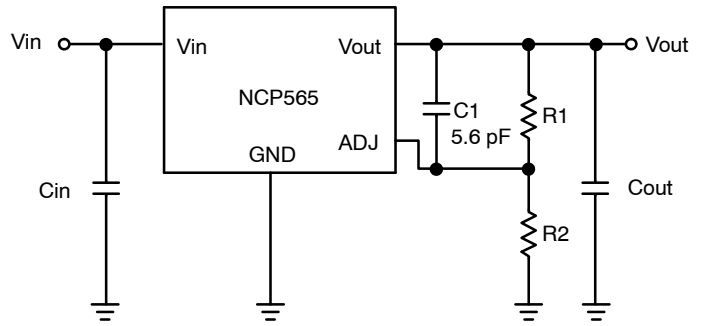
See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 11.

## NCP565, NCV565



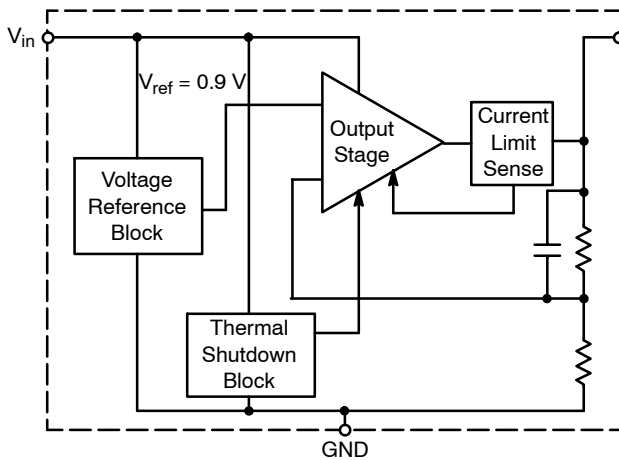
**Figure 1. Typical Application Schematic,  
Fixed Output**



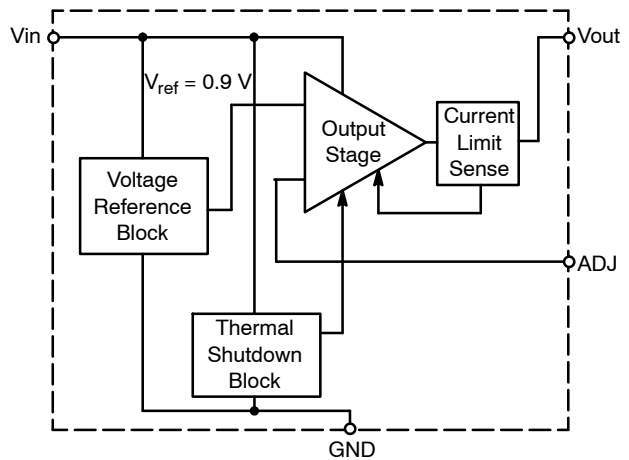
**Figure 2. Typical Application Schematic,  
Adjustable Output**

### PIN DESCRIPTION

| D <sup>2</sup> PAK 5    | D <sup>2</sup> PAK 3     | DFN6                    |                          | SOT-223                  | Symbol           | Description                                                                                                                                                                                                                 |
|-------------------------|--------------------------|-------------------------|--------------------------|--------------------------|------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Pin No.<br>Adj. Version | Pin No.<br>Fixed Version | Pin No.<br>Adj. Version | Pin No.<br>Fixed Version | Pin No.<br>Fixed Version |                  |                                                                                                                                                                                                                             |
| 1                       | –                        | 1, 2                    | 1, 2, 5                  | –                        | N.C.             | –                                                                                                                                                                                                                           |
| 2                       | 1                        | 3                       | 3                        | 3                        | V <sub>in</sub>  | Positive Power Supply Input Voltage                                                                                                                                                                                         |
| 3, Tab                  | 2, Tab                   | 6                       | 6                        | 1                        | Ground           | Power Supply Ground                                                                                                                                                                                                         |
| 4                       | 3                        | 4                       | 4                        | 2, Tab                   | V <sub>out</sub> | Regulated Output Voltage                                                                                                                                                                                                    |
| 5                       | –                        | 5                       | –                        | –                        | Adj              | This pin is to be connected to the sense resistors on the output. The linear regulator will attempt to maintain 0.9 V between this pin and ground. Refer to the Application Information section for output voltage setting. |



**Figure 3. Block Diagram, Fixed Output**



**Figure 4. Block Diagram, Adjustable Output**

# NCP565, NCV565

## ABSOLUTE MAXIMUM RATINGS

| Rating                 | Symbol    | Value                    | Unit |
|------------------------|-----------|--------------------------|------|
| Input Voltage (Note 1) | $V_{in}$  | 18                       | V    |
| Output Pin Voltage     | $V_{out}$ | $-0.3$ to $V_{in} + 0.3$ | V    |
| Adjust Pin Voltage     | $V_{adj}$ | $-0.3$ to $V_{in} + 0.3$ | V    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NOTE: This device series contains ESD protection and exceeds the following tests:

Human Body Model JESD 22-A114-B

Machine Model JESD 22-A115-A

## THERMAL CHARACTERISTICS

| Rating                                                                                                                                                                                  | Symbol                                                | Value        | Unit                 |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------|--------------|----------------------|
| Thermal Characteristics SOT-223 (Notes 1, 2)<br>Thermal Resistance, Junction-to-Ambient<br>Thermal Resistance, Junction-to-Pin                                                          | $R_{\theta JA}$<br>$R_{\theta JP}$                    | 107<br>12    | $^{\circ}\text{C/W}$ |
| Thermal Characteristics DFN6 (Notes 1, 2)<br>Thermal Resistance, Junction-to-Ambient<br>Thermal Resistance, Junction-to-Pin                                                             | $R_{\theta JA}$<br>$R_{\theta JP}$                    | 176<br>37    | $^{\circ}\text{C/W}$ |
| Thermal Characteristics D <sup>2</sup> PAK (5ld) (Notes 1, 2)<br>Thermal Resistance, Junction-to-Case<br>Thermal Resistance, Junction-to-Ambient<br>Thermal Resistance, Junction-to-Pin | $R_{\theta JC}$<br>$R_{\theta JA}$<br>$R_{\theta JP}$ | 3<br>83<br>4 | $^{\circ}\text{C/W}$ |

## OPERATING RANGES

| Rating                               | Symbol    | Value                                     | Unit               |
|--------------------------------------|-----------|-------------------------------------------|--------------------|
| Operating Input Voltage (Note 1)     | $V_{in}$  | $V_{out} + V_{DO}$ ,<br>2.5 (Note 3) to 9 | V                  |
| Operating Junction Temperature Range | $T_J$     | $-40$ to $150$                            | $^{\circ}\text{C}$ |
| Operating Ambient Temperature Range  | $T_A$     | $-40$ to $125$                            | $^{\circ}\text{C}$ |
| Storage Temperature Range            | $T_{stg}$ | $-55$ to $150$                            | $^{\circ}\text{C}$ |

1. Refer to Electrical Characteristics and Application Information for Safe Operating Area.

2. As measured using a copper heat spreading area of 50 mm<sup>2</sup> for SOT-223 and DFN6, 100 mm<sup>2</sup> for D<sup>2</sup>PAK, 1 oz copper thickness.

3. Minimum  $V_{in} = (V_{out} + V_{DO})$  or 2.5 V, whichever is higher.

# NCP565, NCV565

**ELECTRICAL CHARACTERISTICS** ( $V_{in} = V_{out} + 1.6\text{ V}$ ,  $V_{out} = 0.9\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_{in} = C_{out} = 150\text{ }\mu\text{F}$ , unless otherwise noted, Note 4.)

| Characteristic                                                                                                                                             | Symbol       | Min            | Typ  | Max            | Unit             |
|------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|----------------|------|----------------|------------------|
| <b>ADJUSTABLE OUTPUT VERSION</b>                                                                                                                           |              |                |      |                |                  |
| Reference Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $V_{out} + 1.6\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ ) | $V_{ref}$    | 0.882<br>(-2%) | 0.9  | 0.918<br>(+2%) | V                |
| Reference Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $V_{out} + 1.6\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ ) | $V_{ref}$    | 0.873<br>(-3%) | 0.9  | 0.927<br>(+3%) | V                |
| ADJ Pin Current (Note 5)                                                                                                                                   | $I_{Adj}$    | –              | 30   | –              | nA               |
| Line Regulation ( $I_{out} = 10\text{ mA}$ ) (Note 5)                                                                                                      | $Reg_{line}$ | –              | 0.03 | –              | %                |
| Load Regulation ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ) (Note 5)                                                                                       | $Reg_{load}$ | –              | 0.03 | –              | %                |
| Dropout Voltage ( $I_{out} = 1.5\text{ A}$ , $V_{out} = 2.5\text{ V}$ ) (Note 6)                                                                           | $V_{do}$     | –              | 0.9  | 1.3            | V                |
| Current Limit                                                                                                                                              | $I_{lim}$    | 1.6            | 3.3  | –              | A                |
| Ripple Rejection (120 Hz; $I_{out} = 1.5\text{ A}$ ) (Note 5)                                                                                              | RR           | –              | 85   | –              | dB               |
| Ripple Rejection (1 kHz; $I_{out} = 1.5\text{ A}$ ) (Note 5)                                                                                               | RR           | –              | 75   | –              | dB               |
| Ground Current ( $I_{out} = 1.5\text{ A}$ )                                                                                                                | $I_{GND}$    | –              | 1.5  | 3.0            | mA               |
| Output Noise Voltage ( $f = 100\text{ Hz to }100\text{ kHz}$ , $I_{out} = 1.5\text{ A}$ ) (Note 5)                                                         | $V_n$        | –              | 28   | –              | $\mu\text{Vrms}$ |
| Thermal Shutdown Protection (Note 5)                                                                                                                       | $T_{SHD}$    | –              | 160  | –              | $^\circ\text{C}$ |

**FIXED OUTPUT VOLTAGE** ( $V_{in} = V_{out} + 1.6\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_{in} = C_{out} = 150\text{ }\mu\text{F}$ , unless otherwise noted, Note 4.)

|                                                                                                                                                                |              |                |      |                |                  |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|----------------|------|----------------|------------------|
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $2.8\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ )<br>1.2 V version | $V_{out}$    | 1.176<br>(-2%) | 1.2  | 1.224<br>(+2%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $2.8\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ )<br>1.2 V version | $V_{out}$    | 1.164<br>(-3%) | 1.2  | 1.236<br>(+3%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $3.1\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ )<br>1.5 V version | $V_{out}$    | 1.470<br>(-2%) | 1.5  | 1.530<br>(+2%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $3.1\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ )<br>1.5 V version | $V_{out}$    | 1.455<br>(-3%) | 1.5  | 1.545<br>(+3%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.4\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ )<br>2.8 V version | $V_{out}$    | 2.744<br>(-2%) | 2.8  | 2.856<br>(+2%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.4\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ )<br>2.8 V version | $V_{out}$    | 2.716<br>(-3%) | 2.8  | 2.884<br>(+3%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.6\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ )<br>3.0 V version | $V_{out}$    | 2.940<br>(-2%) | 3.0  | 3.060<br>(+2%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.6\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ )<br>3.0 V version | $V_{out}$    | 2.910<br>(-3%) | 3.0  | 3.090<br>(+3%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.9\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -10\text{ to }105^\circ\text{C}$ )<br>3.3 V version | $V_{out}$    | 3.234<br>(-2%) | 3.3  | 3.366<br>(+2%) | V                |
| Output Voltage ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ; $4.9\text{ V} < V_{in} < 9.0\text{ V}$ ; $T_A = -40\text{ to }125^\circ\text{C}$ )<br>3.3 V version | $V_{out}$    | 3.201<br>(-3%) | 3.3  | 3.399<br>(+3%) | V                |
| Line Regulation ( $I_{out} = 10\text{ mA}$ ) (Note 5)                                                                                                          | $Reg_{line}$ | –              | 0.03 | –              | %                |
| Load Regulation ( $10\text{ mA} < I_{out} < 1.5\text{ A}$ ) (Note 5)                                                                                           | $Reg_{load}$ | –              | 0.03 | –              | %                |
| Dropout Voltage ( $I_{out} = 1.5\text{ A}$ , $V_{out} = 2.5\text{ V}$ ) (Note 6)                                                                               | $V_{do}$     | –              | 0.9  | 1.3            | V                |
| Current Limit                                                                                                                                                  | $I_{lim}$    | 1.6            | 3.3  | –              | A                |
| Ripple Rejection (120 Hz; $I_{out} = 1.5\text{ A}$ ) (Note 5)                                                                                                  | RR           | –              | 85   | –              | dB               |
| Ripple Rejection (1 kHz; $I_{out} = 1.5\text{ A}$ ) (Note 5)                                                                                                   | RR           | –              | 75   | –              | dB               |
| Ground Current ( $I_{out} = 1.5\text{ A}$ )                                                                                                                    | $I_{GND}$    | –              | 1.5  | 3.0            | mA               |
| Output Noise Voltage ( $f = 100\text{ Hz to }100\text{ kHz}$ , $V_{out} = 1.2\text{ V}$ , $I_{out} = 1.5\text{ A}$ ) (Note 5)                                  | $V_n$        | –              | 38   | –              | $\mu\text{Vrms}$ |
| Thermal Shutdown Protection (Note 5)                                                                                                                           | $T_{SHD}$    | –              | 160  | –              | $^\circ\text{C}$ |

- Performance guaranteed over specified operating conditions by design, guard banded test limits, and/or characterization, production tested at  $T_J = T_A = 25^\circ\text{C}$ . Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
- Typical values are based on design and/or characterization.
- Dropout voltage is a measurement of the minimum input/output differential at full load.

TYPICAL CHARACTERISTICS

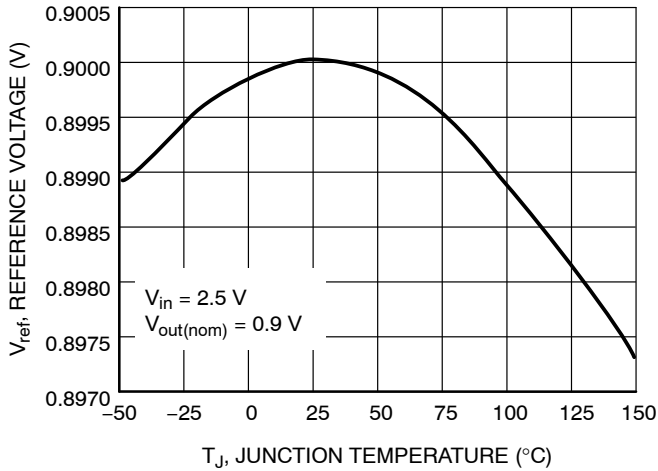


Figure 5. Output Voltage vs. Temperature

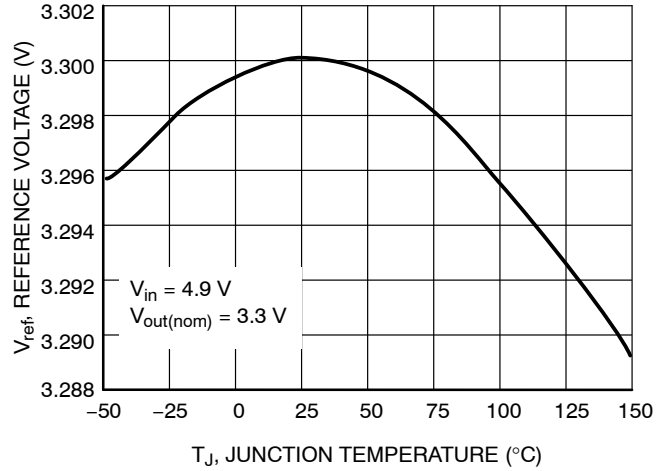


Figure 6. Output Voltage vs. Temperature

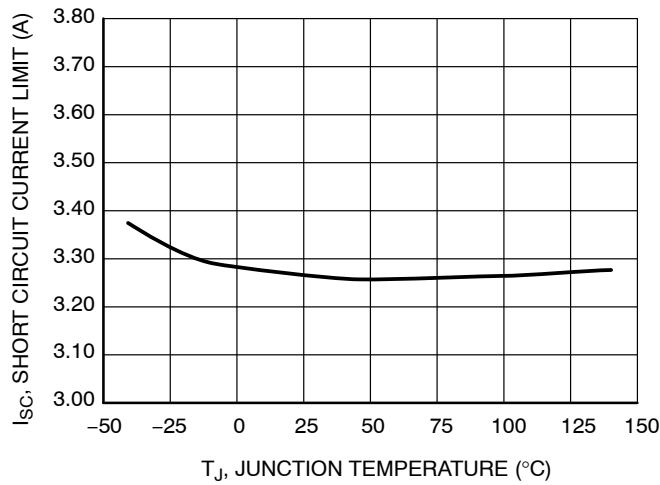


Figure 7. Short Circuit Current Limit vs. Temperature

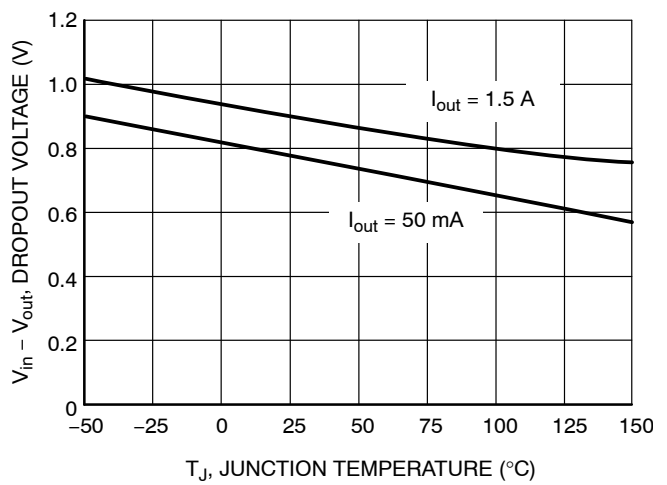


Figure 8. Dropout Voltage vs. Temperature

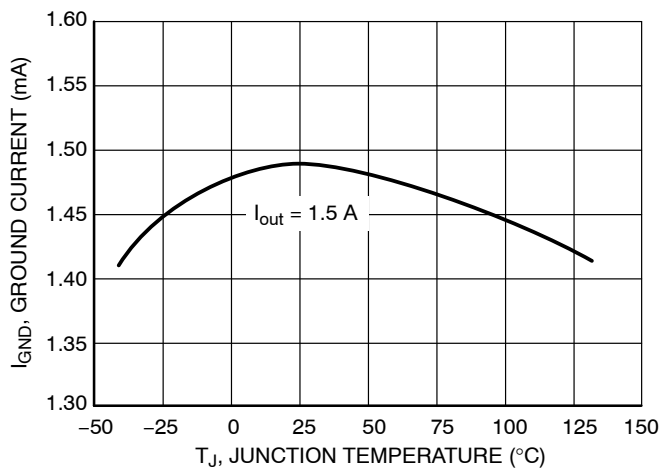


Figure 9. Ground Current vs. Temperature

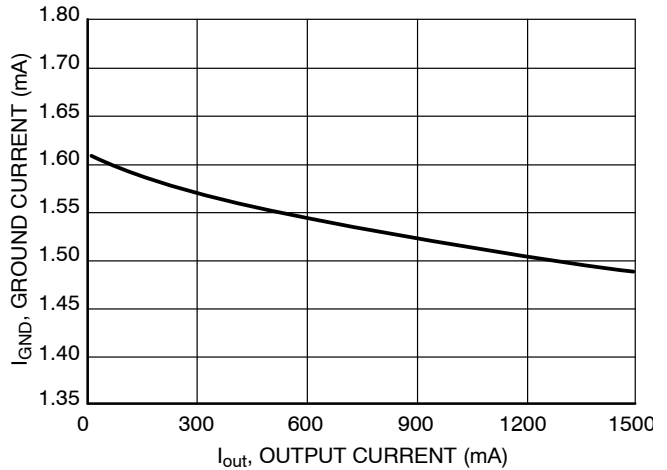


Figure 10. Ground Current vs. Output Current

TYPICAL CHARACTERISTICS

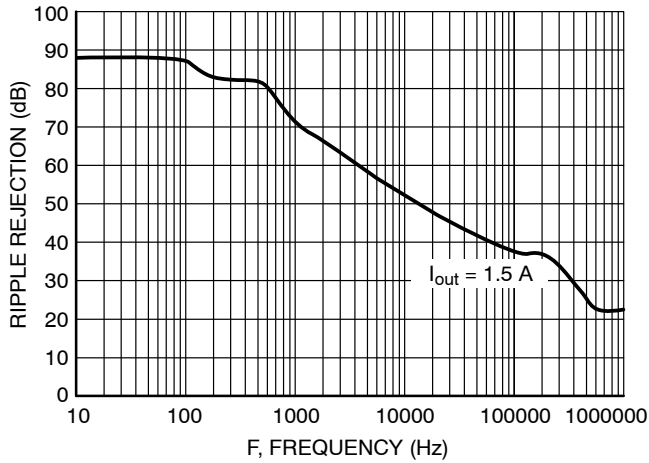


Figure 11. Ripple Rejection vs. Frequency

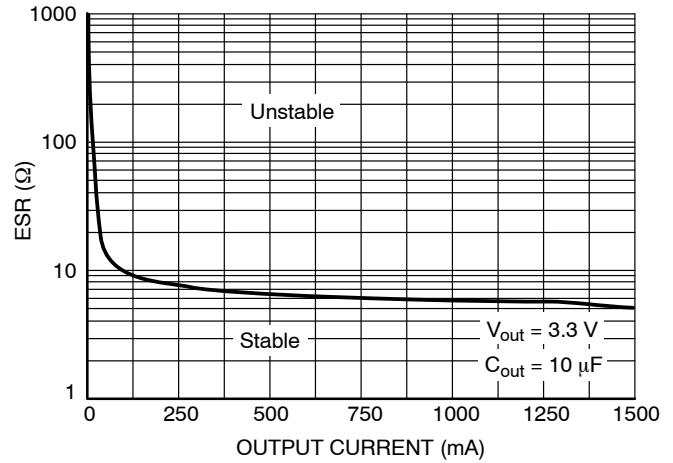


Figure 12. Output Capacitor ESR Stability vs. Output Current

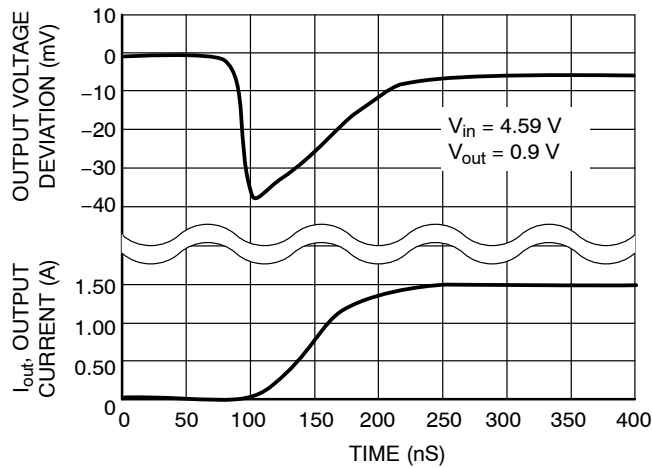


Figure 13. Load Transient from 10 mA to 1.5 A

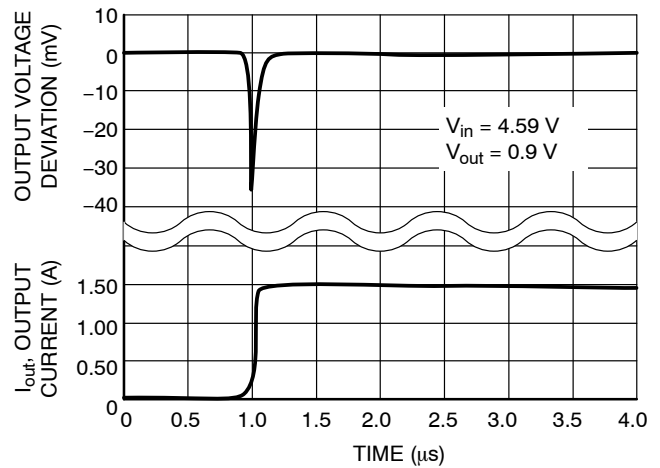


Figure 14. Load Transient from 10 mA to 1.5 A

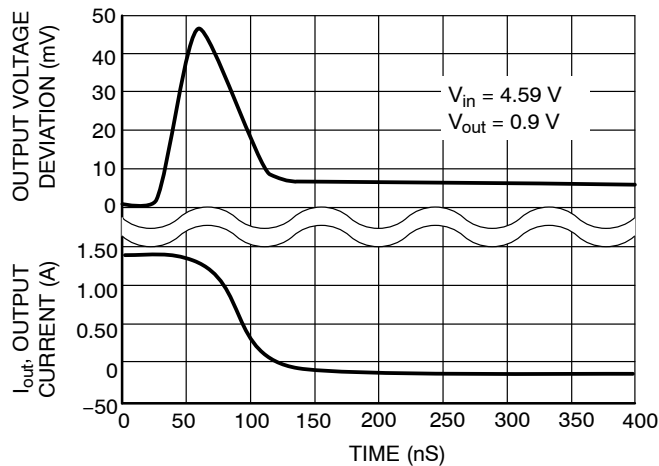


Figure 15. Load Transient from 1.5 A to 10 mA

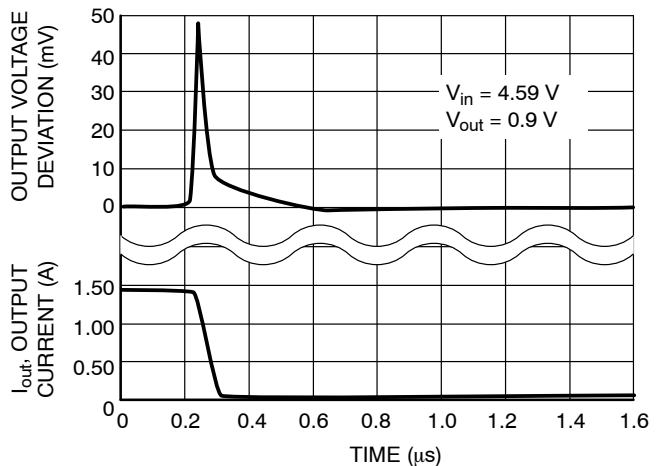


Figure 16. Load Transient from 1.5 A to 10 mA

## TYPICAL CHARACTERISTICS

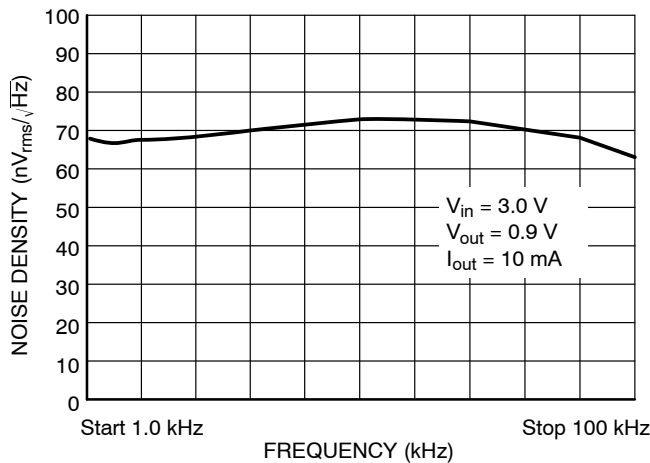


Figure 17. Noise Density vs. Frequency

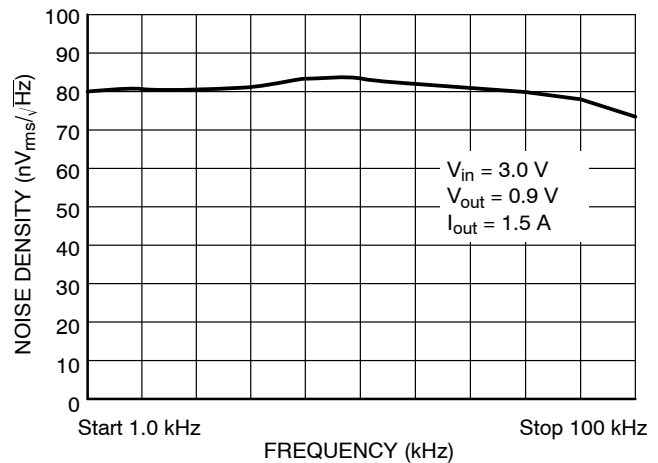


Figure 18. Noise Density vs. Frequency

NOTE: Typical characteristics were measured with the same conditions as electrical characteristics.

## APPLICATION INFORMATION

The NCP565 low dropout linear regulator provides adjustable voltages at currents up to 1.5 A. It features ultra fast transient response and low dropout voltage. These devices contain output current limiting, short circuit protection and thermal shutdown protection.

### Input, Output Capacitor and Stability

An input bypass capacitor is recommended to improve transient response or if the regulator is located more than a few inches from the power source. This will reduce the circuit's sensitivity to the input line impedance at high frequencies and significantly enhance the output transient response. Different types and different sizes of input capacitors can be chosen dependent on the quality of power supply. A 150  $\mu$ F OSCON 16SA150M type from Sanyo should be adequate for most applications. The bypass capacitor should be mounted with shortest possible lead or track length directly across the regulator's input terminals.

The output capacitor is required for stability. The NCP565 remains stable with ceramic, tantalum, and aluminum-electrolytic capacitors with a minimum value of 1.0  $\mu$ F with ESR between 50 m $\Omega$  and 2.5  $\Omega$ . The NCP565 is optimized for use with a 150  $\mu$ F OSCON 16SA150M type in parallel with a 10  $\mu$ F OSCON 10SL10M type from Sanyo. The 10  $\mu$ F capacitor is used for best AC stability while 150  $\mu$ F capacitor is used for achieving excellent output transient response. The output capacitors should be placed as close as possible to the output pin of the device. If not, the excellent load transient response of NCP565 will be degraded.

### Adjustable Operation

The typical application circuit for the adjustable output regulators is shown in Figure 2. The adjustable device develops and maintains the nominal 0.9 V reference voltage between Adj and ground pins. A resistor divider network R1 and R2 causes a fixed current to flow to ground. This current creates a voltage across R1 that adds to the 0.9 V across R2 and sets the overall output voltage.

The output voltage is set according to the formula:

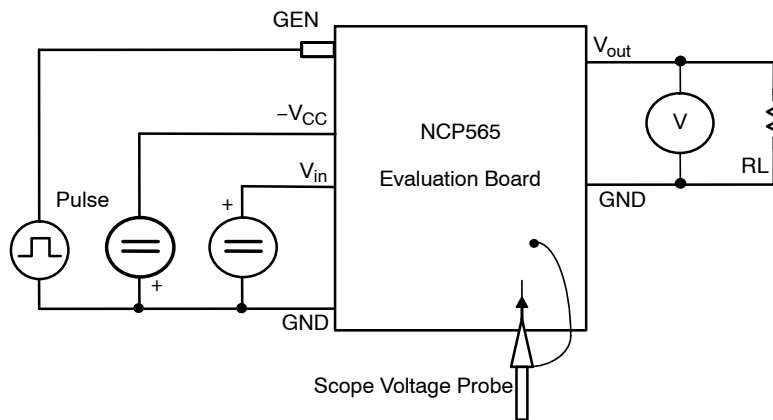
$$V_{out} = V_{ref} \times \left( \frac{R1 + R2}{R2} \right) - I_{Adj} \times R2$$

The adjust pin current,  $I_{Adj}$ , is typically 30 nA and normally much lower than the current flowing through R1 and R2, thus it generates a small output voltage error that can usually be ignored.

### Load Transient Measurement

Large load current changes are always presented in microprocessor applications. Therefore good load transient performance is required for the power stage. NCP565 has the feature of ultra fast transient response. Its load transient responses in Figures 13 through 16 are tested on evaluation board shown in Figure 19. On the evaluation board, it consists of NCP565 regulator circuit with decoupling and filter capacitors and the pulse controlled current sink to obtain load current transitions. The load current transitions are measured by current probe. Because the signal from current probe has some time delay, it causes un-synchronization between the load current transition and output voltage response, which is shown in Figures 13 through 16.

## NCP565, NCV565

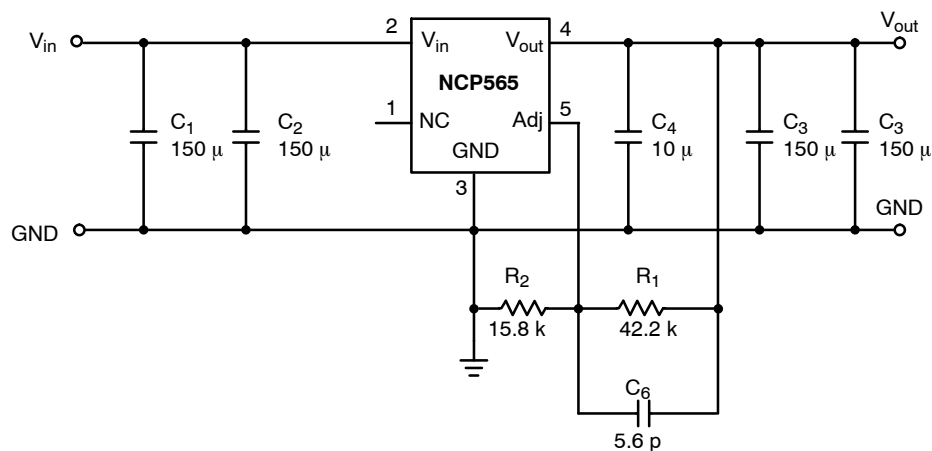


**Figure 19. Schematic for Transient Response Measurement**

### PCB Layout Considerations

Good PCB layout plays an important role in achieving good load transient performance. Because it is very sensitive to its PCB layout, particular care has to be taken when tackling Printed Circuit Board (PCB) layout. The figures below give an example of a layout where parasitic elements are minimized. For microprocessor applications it is customary to use an output capacitor network consisting of

several capacitors in parallel. This reduces the overall ESR and reduces the instantaneous output voltage drop under transient load conditions. The output capacitor network should be as close as possible to the load for the best results. The schematic of NCP565 typical application circuit, which this PCB layout is base on, is shown in Figure 20. The output voltage is set to 3.3 V for this demonstration board according to the feedback resistors in the Table 1.



**Figure 20. Schematic of NCP565 Typical Application Circuit**

# NCP565, NCV565

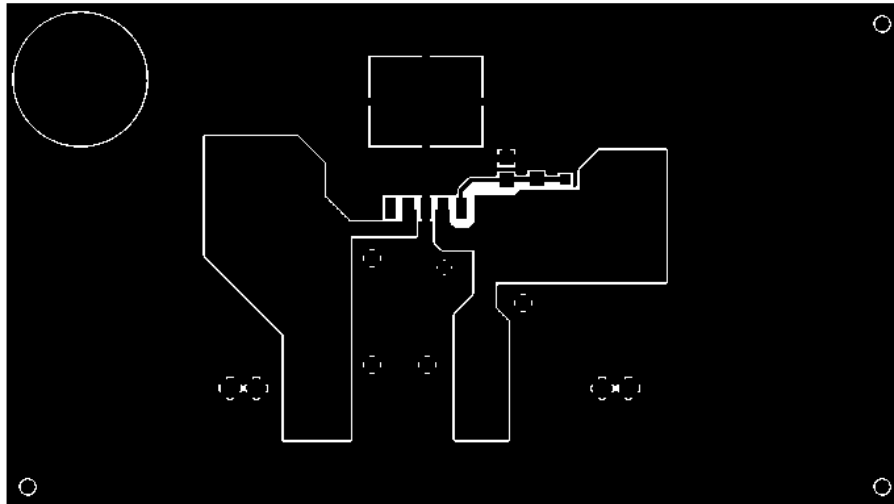


Figure 21. Top Layer

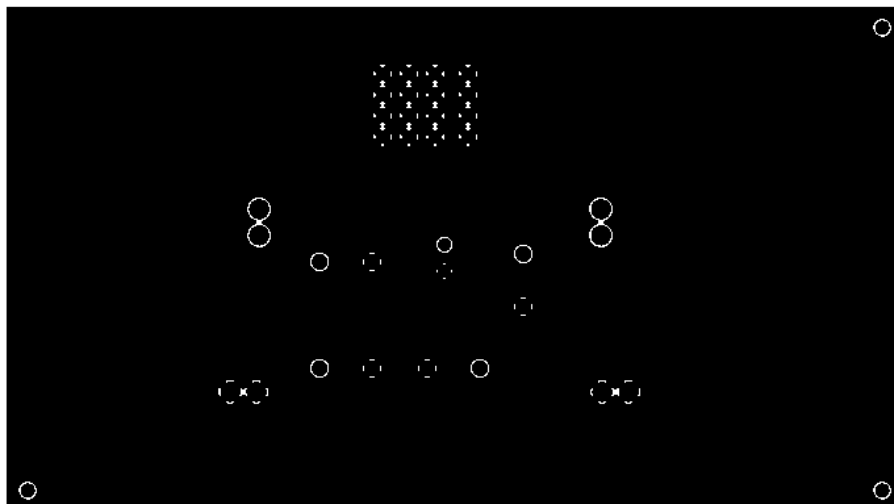


Figure 22. Bottom Layer

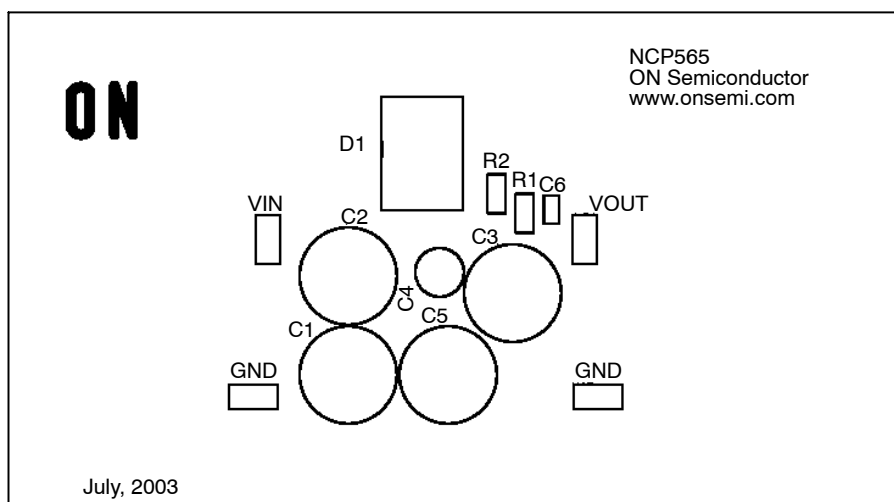


Figure 23. Silkscreen Layer

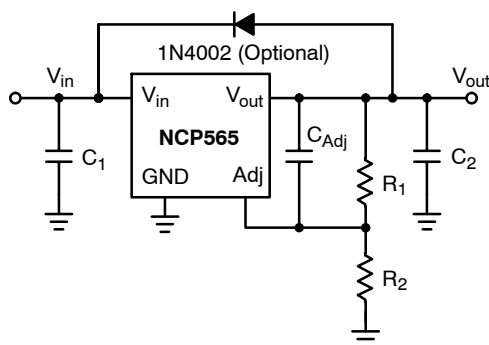
# NCP565, NCV565

**Table 1. Bill of Materials for NCP565 Adj Demonstration Board**

| Item | Used # | Component                                          | Designators    | Suppliers   | Part Number    |
|------|--------|----------------------------------------------------|----------------|-------------|----------------|
| 1    | 4      | Radial Lead Aluminum Capacitor<br>150 $\mu$ F/16 V | C1, C2, C3, C5 | Sanyo Oscon | 16SA150M       |
| 2    | 1      | Radial Lead Aluminum Capacitor<br>10 $\mu$ F/10 V  | C4             | Sanyo Oscon | 10SL10M        |
| 3    | 1      | SMT Chip Resistor (0805) 15.8 K 1%                 | R2             | Vishay      | CRCW08051582F  |
| 4    | 1      | SMT Chip Resistor (0805) 42.2 K 1%                 | R1             | Vishay      | CRCW08054222F  |
| 5    | 1      | SMT Ceramic Capacitor (0603) 5.6 pF 10%            | C6             | Vishay      | VJ0603A5R6KXAA |
| 6    | 1      | NCP565 Low Dropout Linear Regulator                | U1             | onsemi      | NCP565D2TR4    |

## Protection Diodes

When large external capacitors are used with a linear regulator it is sometimes necessary to add protection diodes. If the input voltage of the regulator gets shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage and the rate at which  $V_{in}$  drops. In the NCP565 linear regulator, the discharge path is through a large junction and protection diodes are not usually needed. If the regulator is used with large values of output capacitance and the input voltage is instantaneously shorted to ground, damage can occur. In this case, a diode connected as shown in Figure 24 is recommended.

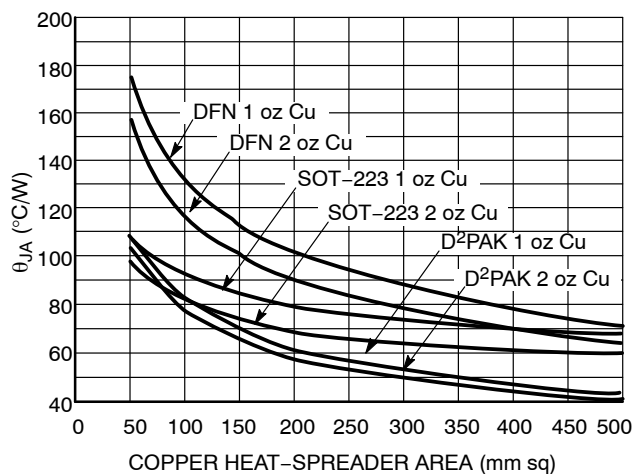


**Figure 24. Protection Diode for Large Output Capacitors**

## Thermal Considerations

This series contains an internal thermal limiting circuit that is designed to protect the regulator in the event that the maximum junction temperature is exceeded. This feature provides protection from a catastrophic device failure due to accidental overheating. It is not intended to be used as a substitute for proper heat sinking. The maximum device power dissipation can be calculated by:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$



**Figure 25. Thermal Resistance**

# NCP565, NCV565

## ORDERING INFORMATION

| Device          | Nominal Output Voltage** | Package                        | Shipping†          |
|-----------------|--------------------------|--------------------------------|--------------------|
| NCP565ST12T3G   | Fixed (1.2 V)            | SOT-223 (Pb-Free)              | 4000 / Tape & Reel |
| NCP565D2T33R4G  | Fixed (3.3 V)            | D <sup>2</sup> PAK 3 (Pb-Free) | 800 / Tape & Reel  |
| NCV565D2T12R4G* | Fixed (1.2 V)            | D <sup>2</sup> PAK 3 (Pb-Free) | 800 / Tape & Reel  |

## DISCONTINUED (Note 7)

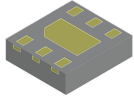
|                |               |                                |                    |
|----------------|---------------|--------------------------------|--------------------|
| NCP565D2TG     | Adj           | D <sup>2</sup> PAK 5 (Pb-Free) | 50 Units / Tube    |
| NCP565D2TR4G   |               | D <sup>2</sup> PAK 5 (Pb-Free) | 800 / Tape & Reel  |
| NCP565MNADJT2G |               | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCP565D2T12G   | Fixed (1.2 V) | D <sup>2</sup> PAK 3 (Pb-Free) | 50 Units / Tube    |
| NCP565D2T12R4G |               | D <sup>2</sup> PAK 3 (Pb-Free) | 800 / Tape & Reel  |
| NCP565MN12T2G  |               | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCP565MN15T2G  | Fixed (1.5 V) | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCP565MN28T2G  | Fixed (2.8 V) | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCP565MN30T2G  | Fixed (3.0 V) | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCP565D2T33G   | Fixed (3.3 V) | D <sup>2</sup> PAK 3 (Pb-Free) | 50 Units / Tube    |
| NCP565MN33T2G  |               | DFN6 (Pb-Free)                 | 3000 / Tape & Reel |
| NCV565D2TG*    | Adj           | D <sup>2</sup> PAK 5 (Pb-Free) | 50 Units / Tube    |
| NCV565D2TR4G*  |               |                                | 800 / Tape & Reel  |
| NCV565ST12T3G* | Fixed (1.2 V) | SOT-223 (Pb-Free)              | 4000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

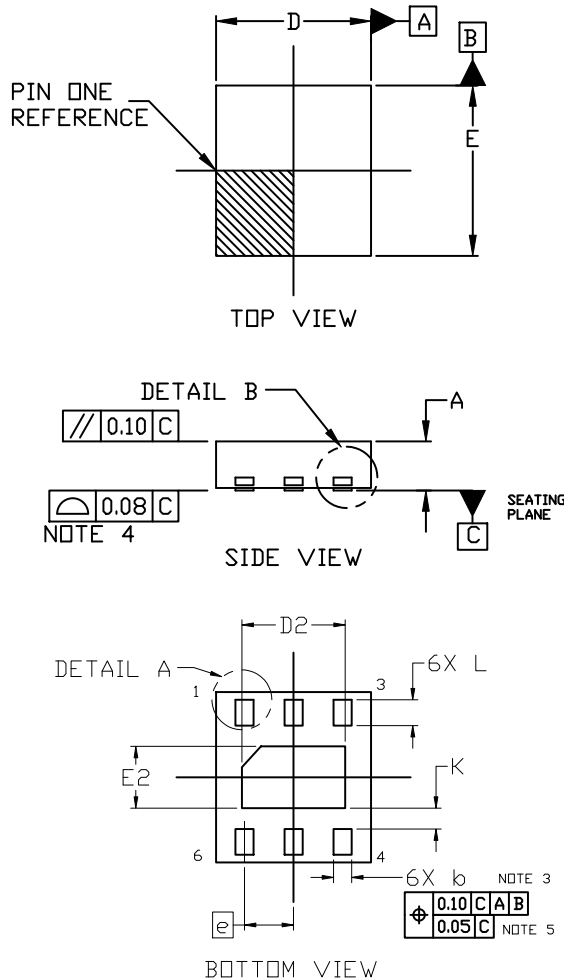
\*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

\*\*For other fixed output versions, please contact the factory. The max Vout available for SOT-223 is 1.2 V.

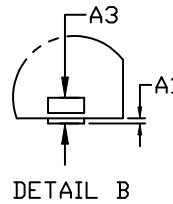
7. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on [www.onsemi.com](http://www.onsemi.com).


**DFN6 3.0x3.3, 0.95P**  
**CASE 506AX**  
**ISSUE A**

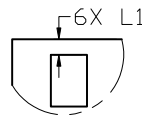
DATE 22 SEP 2020


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION **b** APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. POSITIONAL TOLERANCE APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

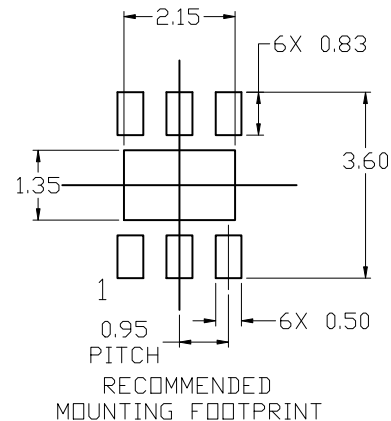


DETAIL B

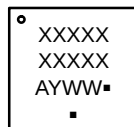


DETAIL A

| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | 0.80        | 0.90 | 1.00 |
| A1  | 0.00        | ---  | 0.05 |
| b   | 0.30        | 0.35 | 0.40 |
| D   | 2.90        | 3.00 | 3.10 |
| D2  | 1.90        | 2.00 | 2.10 |
| E   | 3.20        | 3.30 | 3.40 |
| E2  | 1.10        | 1.20 | 1.30 |
| e   | 0.95 BSC    |      |      |
| K   | 0.40 REF    |      |      |
| L   | 0.40        | 0.50 | 0.60 |
| L1  | 0.00        | ---  | 0.15 |



\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**GENERIC**  
**MARKING DIAGRAM\***


XXXX = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

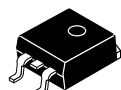
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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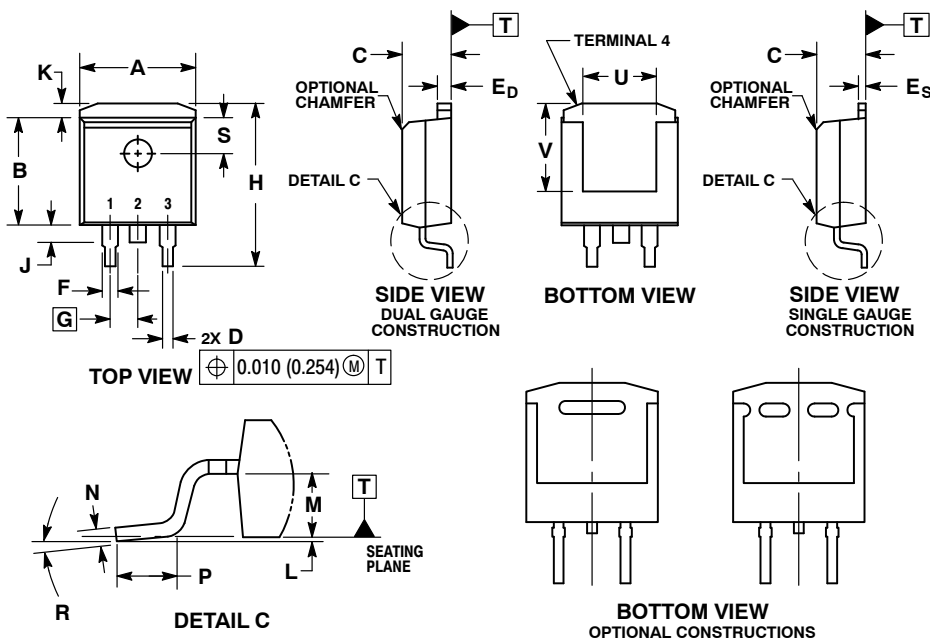
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**SCALE 1:1**

**D<sup>2</sup>PAK**  
CASE 936-03  
ISSUE E

DATE 29 SEP 2015

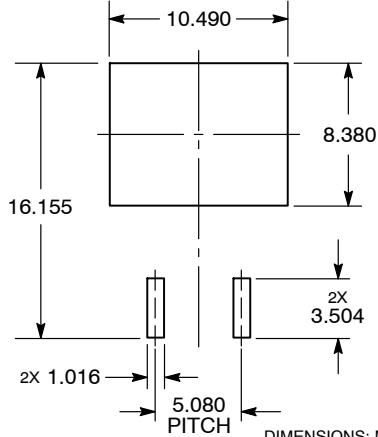


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCHES.
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.
6. SINGLE GAUGE DESIGN WILL BE SHIPPED AFTER PCPN EXPIRATION IN OCTOBER 2011.

|                | INCHES    |       | MILLIMETERS |        |
|----------------|-----------|-------|-------------|--------|
| DIM            | MIN       | MAX   | MIN         | MAX    |
| A              | 0.386     | 0.403 | 9.804       | 10.236 |
| B              | 0.356     | 0.368 | 9.042       | 9.347  |
| C              | 0.170     | 0.180 | 4.318       | 4.572  |
| D              | 0.026     | 0.036 | 0.660       | 0.914  |
| E <sub>D</sub> | 0.045     | 0.055 | 1.143       | 1.397  |
| E <sub>S</sub> | 0.018     | 0.026 | 0.457       | 0.660  |
| F              | 0.051 REF |       | 1.295 REF   |        |
| G              | 0.100 BSC |       | 2.540 BSC   |        |
| H              | 0.539     | 0.579 | 13.691      | 14.707 |
| J              | 0.125 MAX |       | 3.175 MAX   |        |
| K              | 0.050 REF |       | 1.270 REF   |        |
| L              | 0.000     | 0.010 | 0.000       | 0.254  |
| M              | 0.088     | 0.102 | 2.235       | 2.591  |
| N              | 0.018     | 0.026 | 0.457       | 0.660  |
| P              | 0.058     | 0.078 | 1.473       | 1.981  |
| R              | 0°        | 8°    | 0°          | 8°     |
| S              | 0.116 REF |       | 2.946 REF   |        |
| U              | 0.200 MIN |       | 5.080 MIN   |        |
| V              | 0.250 MIN |       | 6.350 MIN   |        |

**RECOMMENDED  
SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual. SOLDERRM/D.

### GENERIC MARKING DIAGRAM\*



XXXXXX = Specific Device Code

A = Assembly Location

L = Wafer Lot

Y = Year

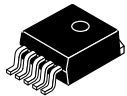
WW = Work Week

G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "u", may or may not be present. Some products may not follow the Generic Marking.

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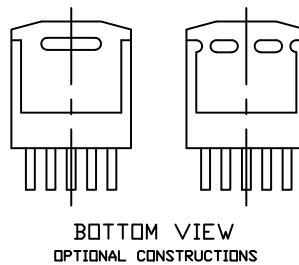
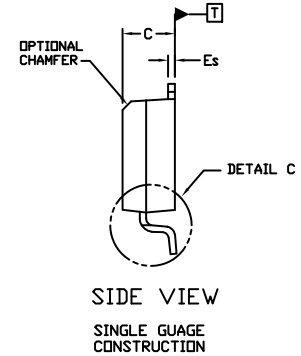
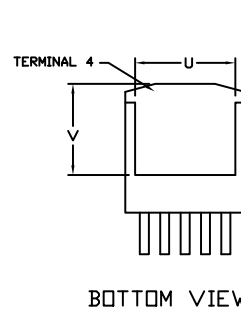
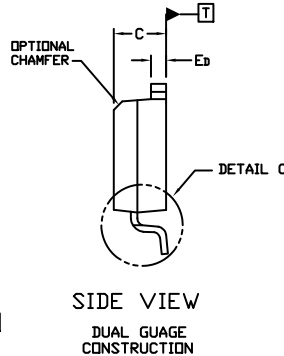
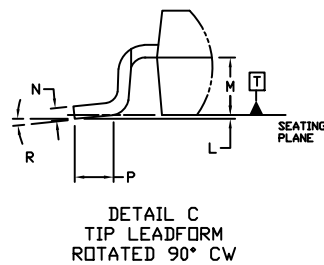
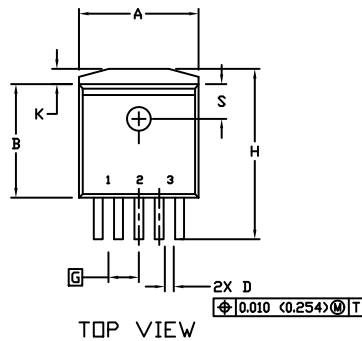
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SCALE 1:1

**D<sup>2</sup>PAK 5-LEAD**  
**CASE 936A-02**  
**ISSUE E**

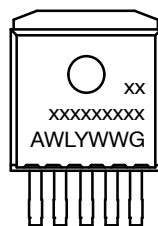
DATE 28 JUL 2021



## NOTES:

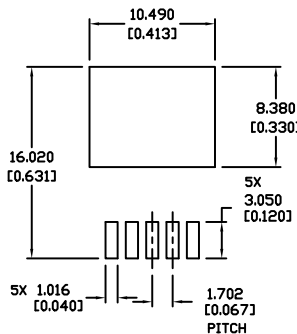
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCHES
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

| DIM | INCHES |       | MILLIMETERS |        |
|-----|--------|-------|-------------|--------|
|     | MIN.   | MAX.  | MIN.        | MAX.   |
| A   | 0.396  | 0.403 | 9.804       | 10.236 |
| B   | 0.356  | 0.368 | 9.042       | 9.347  |
| C   | 0.170  | 0.180 | 4.318       | 4.572  |
| D   | 0.026  | 0.036 | 0.660       | 0.914  |
| Ed  | 0.045  | 0.055 | 1.143       | 1.397  |
| Es  | 0.018  | 0.026 | 0.457       | 0.660  |
| G   | 0.067  | BSC   | 1.702       | BSC    |
| H   | 0.539  | 0.579 | 13.691      | 14.707 |
| K   | 0.050  | REF   | 1.270       | REF    |
| L   | 0.000  | 0.010 | 0.000       | 0.254  |
| M   | 0.088  | 0.102 | 2.235       | 2.591  |
| N   | 0.018  | 0.026 | 0.457       | 0.660  |
| P   | 0.058  | 0.078 | 1.473       | 1.981  |
| R   | 0°     | 8°    | 0°          | 8°     |
| S   | 0.116  | REF   | 2.946       | REF    |
| U   | 0.200  | MIN   | 5.080       | MIN    |
| V   | 0.250  | MIN   | 6.350       | MIN    |

**GENERIC  
MARKING DIAGRAM\***


xxxxxx = Device Code  
A = Assembly Location  
WL = Wafer Lot  
Y = Year  
WW = Work Week  
G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**DESCRIPTION:** D2PAK 5-LEAD

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